

Standard LDO Regulators

Standard Fixed Output LDO Regulators

BA□□DD0 Series, BA□□CC0 Series



Standard Fixed Output LDO Regulators with Shutdown Switch

BA□□DD0W and,BA□□CC0W Series

No.11021ECT01

Description

Standard Fixed Output LDO Regulators are low-saturation regulators, available for output s up to 2A / 1A. ROHM has a wide output voltage range and package lineup with and without shutdown switches. This IC has a built-in over-current protection circuit that prevents the destruction of the IC due to output short circuits, a thermal shut-down circuit that protects the IC from damage due to overloading and an over-voltage protection circuit that protects the IC from surges generated in the power supply line of the IC.

Features

- 1) Maximum output current : 2A (BA \underset DD0),1A(BA \underset CC0)
- 2) ±1% highly accurate output voltage (BA□□DD0)
- 3) Low saturation with PNP output
- 4) Built-in over-current protection circuit that prevents the destruction of the IC due to output short circuits
- 5) Built-in thermal shutdown circuit for protecting the IC from damage due to overloading
- 6) Built-in over- voltage protection circuit that prevents the destruction of the IC due to power supply surges
- 7) TO220FP and HRP5 packaging (BA \Boxed DD0) ,TO220FP and TO252 packaging(BA \Boxed CC0)

Applications

Used in DSP power supplies for DVD and CD players, FPDs, televisions, personal computers or any other consumer device

●Line up matrix

■1A BA□□CC0 Series

Part Number	3.0	3.3	5.0	6.0	7.0	8.0	9.0	10	12	15	Package
BA□□CC0WT	0	0	0	_	0	0	0	0	0	_	TO220FP-5
BA□□CC0WFP	_	0	0	0	0	0	0	_	0	_	TO252-5
BA□□CC0T	0	0	0	0	0	0	0	0	0	0	TO220FP-3
BA□□CC0FP	0	0	0	0	0	0	0	0	0	0	TO252-3

■2A BA□□DD0 Series

品 名	1.5	1.8	2.5	3.0	3.3	5.0	9.0	12	16	パッケージ
BA□□DD0WT	0	0	0	0	0	0	0	0	0	TO220FP-5
BA□□DD0WHFP	0	0	0	0	0	0	0	0	0	HRP5
BA□□DD0T	0	0	0	0	0	0	0	0	0	TO220FP-3

Part Number: BA□□CC0□□

a bc

Part Number: E	BA <u>□□</u> D	D0 <u>□□</u>
	а	hс

Symbol	Details								
	Output Voltage Designation								
		Output Voltage (V)		Output Voltage (V)					
	03	3.0V(Typ.)	80	8.0V(Typ.)					
а	033	3.3V(Typ.)	09	9.0V(Typ.)					
	05	5.0V(Typ.)	J0	10.0V(Typ.)					
	06	6.0V(Typ.)	J2	12.0V(Typ.)					
	07	7.0V(Typ.)	J5	15.0V(Typ.)					
b	Switch:"With W":Shutdown switch included "Without W":Shutdown switch not included								
С	Packa	Package T : TO220FP-5,TO220FP-3 FP : TO252-5,TO252-3							

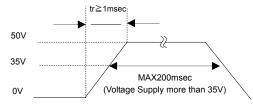
Symbol	Details								
	Output Voltage Designation								
		Output Voltage (V)		Output Voltage (V)					
	15	1.5V(Typ.)	50	5.0V(Typ.)					
а	18	1.8V(Typ.)	90	9.0V(Typ.)					
	25	2.5V(Typ.)	J2	12.0V(Typ.)					
	30	3.0V(Typ.)	J6	16.0V(Typ.)					
	33	3.3V(Typ.)							
b	Switch:"With W":Shutdown switch included "Without W":Shutdown switch not included								
С	Package T : TO220FP-5,TO220FP-3 HFP: HRP5								

● Absolute Maximum Ratings(Ta=25°C)

Soluto Maximum Natings (14-20-0)									
Parameter	Symbol	Ratings	Unit						
Input Power Supply Voltage*1	V _{CC}	-0.3~+35	V						
		2300(HRP5)							
Power Dissipation*2	Pd	1300(TO252-5)	mW						
	Fu	1200(TO252-3)	IIIVV						
		2000(TO220FP-3,5)							
Operating Temperature Range	Topr	-40~+125	°C						
Ambient Storage Temperature	Tstg	-55~+150	°C						
Junction Temperature	Tj _{MAX.}	+150	°C						
Output Control Terminal Voltage*3	Vctl	-0.3∼+Vcc	V						
Voltage Applied to the Tip *4	VCC peak	+50	V						

^{*1} Must not exceed Po

^{*4} Applied voltage : 200msec or less (tr≥1msec)



^{*2} HRP5: In cases in which Ta≥25°C when a 70mm×70mm×1.6mm glass epoxy board is used, the power is reduced by 18.4 mW/°C. TO252FP-3: In cases in which Ta≥25°C when a 70mm×70mm×1.6mm glass epoxy board is used, the power is reduced by 9.6 mW/°C. TO252FP-5: In cases in which Ta≥25°C when a 70mm×70mm×1.6mm glass epoxy board is used, the power is reduced by 10.4 mW/°C. TO220FP-5: No heat sink. When Ta≥25°C, the power is reduced by 16 mW/°C.

^{*3} Only for models with shutdown switches.

● Recommended Operating Range (Ta=25°C)

Parameter		Symbol		Ratings	Ratings		
		Symbol	Min.	Min. Typ.		Unit	
Input	BA□□CC0	\/	4.0	_	25.0	V	
PowerSupply Voltage	BA□□DD0	V _{CC}	3.0	_	25.0	V	
Output Current	BA□□CC0	lo	_	_	1	Α	
Output Current	BA□□DD0	10		_	2	Α	
Output Control Terminal Voltage		Vctl	0	_	V _{CC}	V	

● Electrical Characteristics (ABRIDGED)

BADDCO Series (unless specified otherwise, Ta=25°C, VCTL=5.0V(only with switch), Io=500mA, and Vcc= VccD^{*5})

BALILICO Series (uniess specified	otnerwise	, 1a=25 C, V	/CTL=5.0V	(only with st	witch), io=500mA,and vcc= vccD)		
Parameter	Symbol		Limits		Unit	Conditions	
	Symbol	Min.	Тур.	Max.	Offic	Conditions	
Output Voltage	Vo	Vo×0.98	Vo	Vo × 1.02	V	Refer to the lineup for Vo	
Circuit Current at Shutdown	Isd	_	0	10	μΑ	VCTL=0V	
Minimum I/O Difference	ΔVd	_	0.3	0.5	V	Vcc= 0.95 × Vo	
Output Current Capacity	lo	1.0	_	_	А		
Input Stability	Reg.I	_	20	100	mV	Vcc= (Vo+1)V → 25V	
Load Stability	Reg.L	_	50	100	mV	Io=5mA→1A	
Output Voltage Temperature Coefficient*6	Tcvo	_	±0.02	_	%/°C	Io=5mA ,Tj=0~125°C	

BA00DD0 series (unless specified otherwise, Ta=25°C, VcTL=3V(only with switch), Io=500mA, and Vcc=Vccp^{*7})

Parameter	Cymbol		Limits		Unit	Canditions
	Symbol	Min.	Тур.	Max.	Oill	Conditions
Output Voltage	Vo	Vo×0.99	Vo	Vo × 1.01	V	lo=200mA
Circuit Current at Shutdown	Isd	_	0	10	μA	VCTL=0V
Minimum I/O Difference	ΔVd	_	0.45	0.7	٧	Vcc= 0.95 × Vo, Io=2A
Output Current Capacity	lo	2.0	_	_	Α	
Input Stability	Reg.I	_	15	50	mV	Vcc= Vccp ^{*7} →25V, Io=200mA
Load Stability	Reg.L	_	50	200	mV	Io=5mA→2A
Output Voltage Temperature Coefficient*6	Tcvo	_	±0.02	_	%/°C	Io=5mA ,Tj=0~125°C

^{*5} Vo=3.0V : Vcc= 8.0V , Vo=3.3V : Vcc=8.3V , Vo=5.0V : Vcc=10.0V , Vo=6.0V : Vcc=11.0V , Vo=7.0V : Vcc=12.0V, Vo=8.0V : Vcc= 13.0V , Vo=9.0V : Vcc=14.0V , Vo=10.0V : Vcc=15.0V , Vo=12.0V : Vcc=17.0V , Vo=15.0V : Vcc=20.0V

^{*6} Design guarantee (100% shipping inspection not performed)

^{*7} Vo=1.5V , 1.8V , 2.5V , 3.0V : Vcc=4.0V , Vo=3.3V , 5.0V : Vcc=7.0V , Vo=9.0V : Vcc=12.0V , Vo=12V : Vcc=14V , Vo=16V : Vcc=18V

● Reference Data (Unless specified otherwise, Vcc=8.3V, Vo=3.3V, VCTL=5.0V, and Io=0mA) BA□□CC0□□(BA33CC0WT)

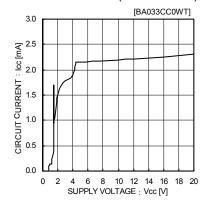


Fig.1 Circuit current

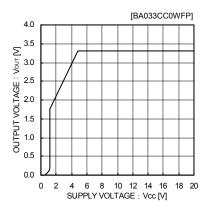


Fig.2 Input Stability

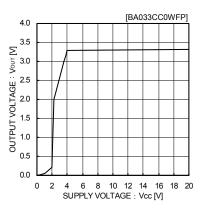


Fig.3 Input Stability (Io=500mA)

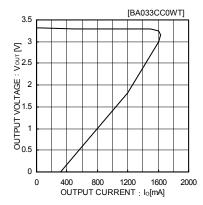


Fig.4 Load Stability

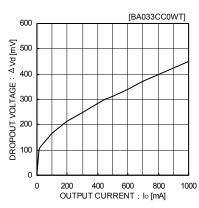


Fig.5 Input/Output Voltage Difference IOUT(0V=1A)

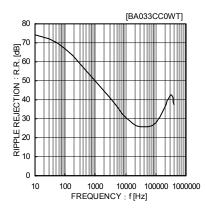


Fig.6 Ripple Rejection Characteristics (Io=100mA)

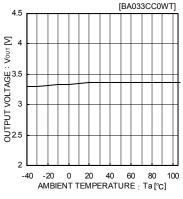


Fig.7 Output Voltage Temperature Characteristics

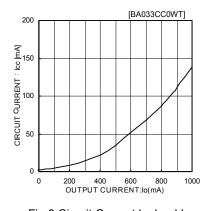


Fig.8 Circuit Current by load Level (Io∪T=0mA→1A)

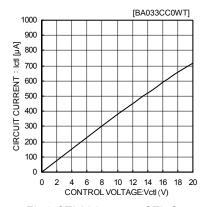


Fig.9 CTL Voltage vs. CTL Current

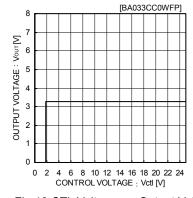


Fig.10 CTL Voltage vs. Output Voltage

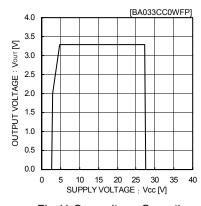


Fig.11 Overvoltage Operating Characteristics (Io=200mA)

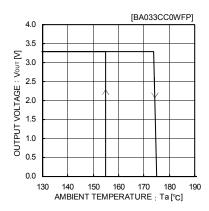


Fig.12 Thermal Shutdown Circuit Characteristics

■Reference Data (Unless specified otherwise, Vcc=7.0V, Vo=5.0V, VcTL=3.0V, and Io=0mA) BA□□DD0□□(BA50DD0WT)

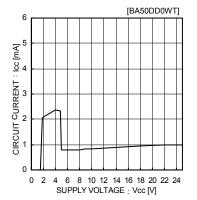


Fig.13 Circuit Current

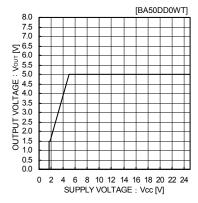


Fig.14 Input Stability

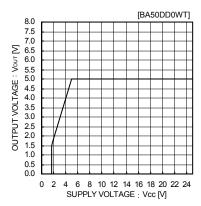


Fig.15 Input Stability (Io=2A)

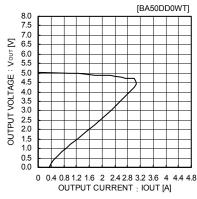


Fig.16 Load Stability

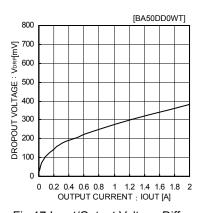


Fig.17 Input/Output Voltage Difference

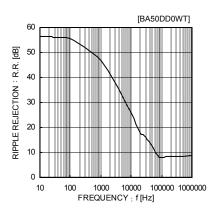


Fig.18 Ripple Rejection Characteristics

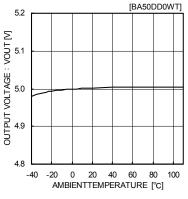


Fig.19 Temperature Characteristics

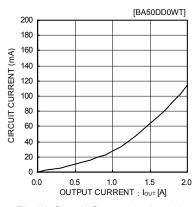


Fig.20 Circuit Current by Load Level

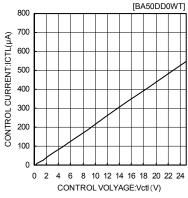


Fig.21 CTL Voltage vs. CTL Current

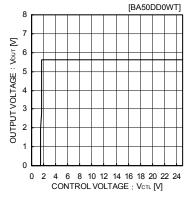


Fig.22 CTL Voltage vs. Output Voltage

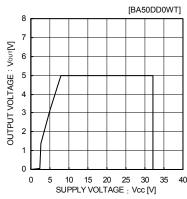


Fig.23 Overvoltage Operating

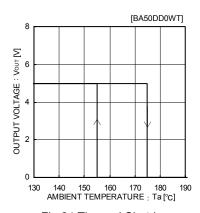
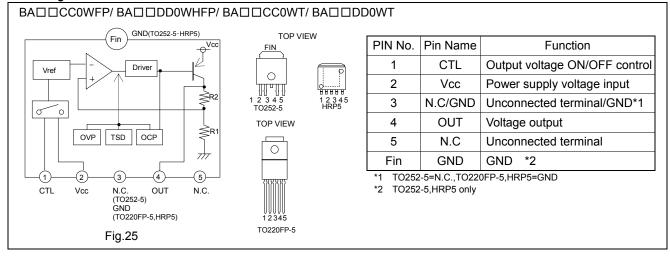
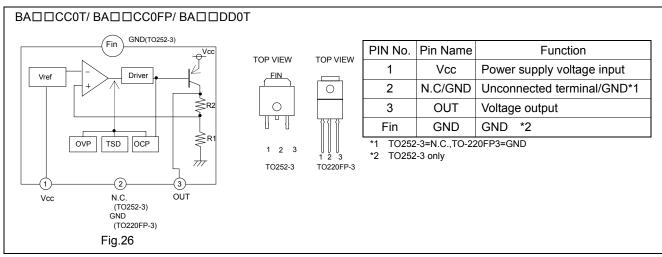


Fig.24 Thermal Shutdown Circuit Characteristics

Block Diagrams

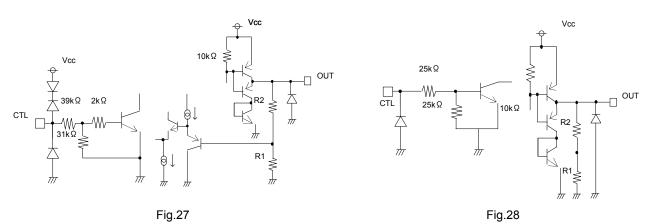




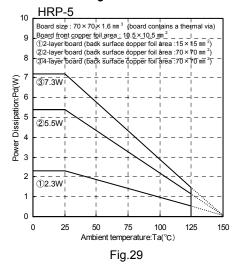
●Input / Output Equivalent Circuit Diagrams

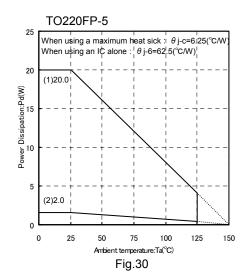
< BA□□DD0 Series >

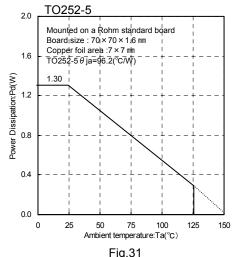
< BA□□CC0 Series >



Thermal Design







When using at temperatures over Ta=25°C, please refer to the heat reducing characteristics shown in Fig.29 through 31. The IC characteristics are closely related to the temperature at which the IC is used and if the temperature exceeds the maximum junction temperature TjMAX., the elements may be damaged or destroyed. From the standpoints of instantaneous destruction and long-term operating reliability, it is necessary give sufficient consideration to IC heat. In order to protect the IC from thermal damage, it is necessary to operate it at temperatures lower than the maximum junction temperature TjMAX of the IC.

Fig.30 shows the acceptable loss and heat reducing characteristics of the TO220FP package The portion shown by the diagonal line is the acceptable loss range that can be used with the IC alone. Even when the ambient temperature Ta is a normal temperature (25°C), the chip (junction) temperature Tj may be quite high so please operate the IC at temperatures less than the acceptable loss Pd.

The method of calculating the power consumption Pc(W) is as follows.

$$Pc = (Vcc-Vo) \times Io + Vcc \times Icca$$

Acceptable loss $Pd \leq Pc$

Vcc :Input voltage
Vo :Output voltage
Io :Load current
Vcca :Circuit current

Solving this for load current IO in order to operate within the acceptable loss:

$$lo \le \frac{Pd - Vcc \times lcca}{Vcc - Vo}$$

(Please refer to Figs.8 and 20 for Icca.)

It is then possible to find the maximum load current lowax with respect to the applied voltage Vcc at the time of thermal design.

Calculation Example

Example 1) When Ta=85°C, Vcc=8.3V, Vo=3.3V, BA33DD0WT

$$\begin{array}{l} \text{Io} \leq \frac{1.04 - 8.3 \times \text{Icca}}{5} \\ \text{Io} \leq 200 \text{mA (Icca : 2mA)} \end{array} \qquad \left(\begin{array}{c} \text{With the IC alone : } \theta \text{ ja=62.5°C/W} \rightarrow \text{-16mW/°C} \\ 25^{\circ}\text{C=2000mW} \rightarrow 85^{\circ}\text{C=1040mW} \end{array} \right)$$

Please refer to the above information and keep thermal designs within the scope of acceptable loss for all operating temperature ranges.

The power consumption Pc of the IC when there is a short circuit (short between Vo and GND) is :

Pc=Vcc × (Icca+Ishort)

*Ishort : Short circuit current

Peripheral Circuit Considerations

Vcc Terminal

Please attach a capacitor (greater than 0.33µF) between the Vcc and GND.

The capacitance values will differ depending on the application, so please take this into account when configuring the terminal.

GND Terminal

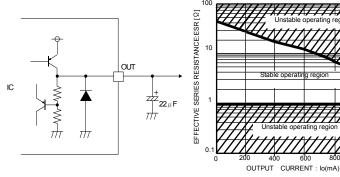
Please be sure to keep the set ground and IC ground at the same potential level so that a potential difference does not arise between them.

If a potential difference arises between the set ground and the IC ground, the preset voltage will not be outputted, causing the system to become unstable. Therefore, please reduce the impedance by making the ground patterns as wide as possible and by reducing the distance between the set ground and the IC ground as much as possible.

· CTL Terminal

The CTL terminal is turned ON at 2.0V and higher and OFF at 0.8V and lower within the operating power supply voltage range. The power supply and the CTL terminal may be started up and shut down in any order without problems.

Vo Terminal



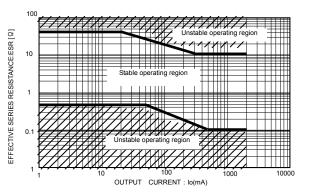


Fig.32 Output Equivalent Circuit

Fig.33 ESR-lo Characteristics (BA□□CC0)

Fig.34 ESR vs lo Characteristics (B A□□DD0)

Please attach an anti-oscillation capacitor between V_{CC} and GND. The capacitance of the capacitor may significantly change due to factors such as temperature changes, making it impossible to completely stop oscillations. Please use a tantalum capacitor or aluminum electrolysis capacitor with favorable characteristics and small internal series resistance (ESR) even at low temperatures. The output fluctuates regardless of whether the ESR is large or small. Please use the IC within the stable operating region while referring to the ESR characteristics reference data shown in Figs.32 through 34. In applications where there are sudden load fluctuations, the use of a capacitor with large capacitance is recommended.

Other Points of Caution

1) Protection Circuits

Over-current Protection Circuit

A built-in over-current protection circuit corresponding to the current capacity prevents the destruction of the IC when there are load shorts. This protection circuit is a "7"-shaped current control circuit that is designed such that the current is restricted and does not latch even when a large current momentarily flows through the system with a high-capacitance capacitor. However, while this protection circuit is effective for the prevention of destruction due to unexpected accidents, it is not suitable for continuous operation or transient use. Please be aware when creating thermal designs that the overcurrent protection circuit has negative current capacity characteristics with regard to temperature (Refer to Figs.4 and 16).

Thermal Shutdown Circuit (Thermal Protection)

This system has a built-in temperature protection circuit for the purpose of protecting the IC from thermal damage.

As shown above, this must be used within the range of acceptable loss, but if the acceptable loss happens to be continuously exceeded, the chip temperature Tj increases, causing the temperature protection circuit to operate.

When the thermal shutdown circuit operates, the operation of the circuit is suspended. The circuit resumes operation immediately after the chip temperature Tj decreases, so the output repeats the ON and OFF states (Please refer to Figs.12 and 24 for the temperatures at which the temperature protection circuit operates).

There are cases in which the IC is destroyed due to thermal runaway when it is left in the overloaded state. Be sure to avoid leaving the IC in the overloaded state.

Reverse Current

In order to prevent the destruction of the IC when a reverse current flows through the IC, it is recommended that a diode be placed between the Vcc and Vo and a pathway be created so that the current can escape (Refer to Fig.35).

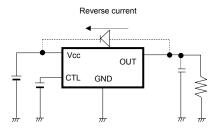


Fig. 36:Bypass diode

2) This IC is bipolar IC that has a P-board (substrate) and P+ isolation layer between each devise, as shown in Fig.36. A P-N junction is formed between this P-layer and the N-layer of each device, and the P-N junction operates as a parasitic diode when the electric potential relationship is GND> Terminal A, GND> Terminal B, while it operates as a parasitic transistor when the electric potential relationship is Terminal B GND> Terminal A. Parasitic devices are structurally inevitable in the IC. The operation of parasitic devices induces mutual interference between circuits, causing malfunctions and eventually the destruction of the IC. It is necessary to be careful not to use the IC in ways that would cause parasitic elements to operate. For example, applying a voltage that is lower than the GND (P-board) to the input terminal.

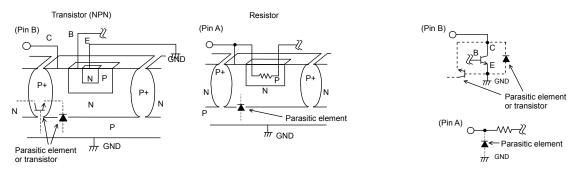
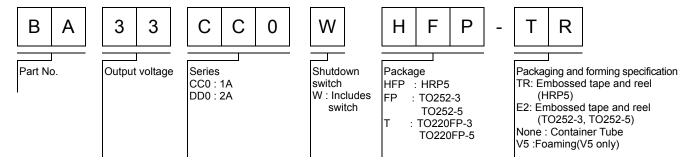
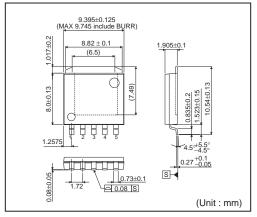


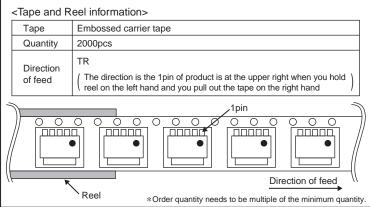
Fig. 37: Example of the basic structure of a bipolar IC

Ordering part number

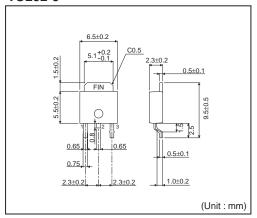


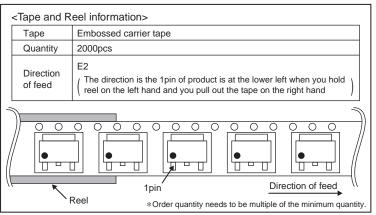
HRP5



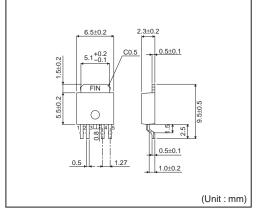


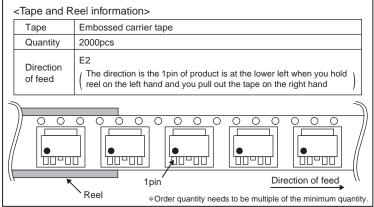
TO252-3



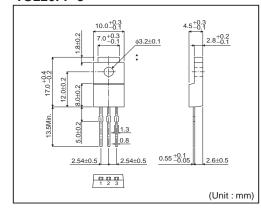


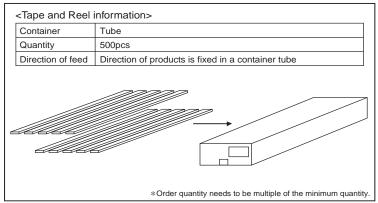
TO252-5



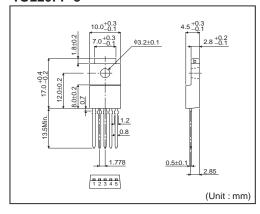


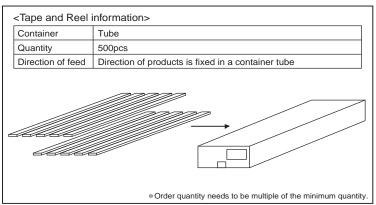
TO220FP-3





TO220FP-5





Notes

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